BLC10G18XS-550AVT

Power LDMOS transistor

AMPLEON

Rev. 1 — 21 December 2017 **Product data sheet**

1. Product profile

1.1 General description

550 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 1805 MHz to 1880 MHz.

Table 1. Typical performance

Typical RF performance at T_{case} = 25 °C in an asymmetrical Doherty production test circuit. V_{DS} = 28 V; I_{Dq} = 800 mA (main); $V_{GS(amp)peak}$ = 0.95 V, unless otherwise specified.

Test signal	f	V_{DS}	$P_{L(AV)}$	G_p	η_D	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
1-carrier W-CDMA	1805 to 1880	28	91	16.5	49.3	−29.4 [1]

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.9 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

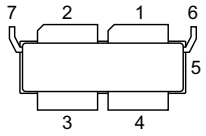
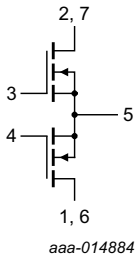
- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 1805 MHz to 1880 MHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain2 (peak)		
2	drain1 (main)		
3	gate1 (main)		
4	gate2 (peak)		
5	source [1]		
6	video decoupling (peak)		
7	video decoupling (main)		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLC10G18XS-550AVT	-	air cavity plastic earless flanged package; 6 leads	SOT1258-4

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
$V_{GS(amp)main}$	main amplifier gate-source voltage		–6	+9	V
$V_{GS(amp)peak}$	peak amplifier gate-source voltage		–6	+9	V
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature	[1]	-	225	°C
T_{case}	case temperature	operating [1]	–40	+125	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	V_{DS} = 32 V; I_{Dq} = 800 mA (main); $V_{GS(amp)peak}$ = 1.1 V; T_{case} = 80 °C		
		P_L = 110 W	0.187	k/W
		P_L = 138 W	0.166	k/W

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6. Characteristics

Table 6. DC characteristics

T_j = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Main device						
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 1.8 mA	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_D = 180 mA	1.5	2.0	2.5	V
V_{GSq}	gate-source quiescent voltage	V_{DS} = 28 V; I_D = 800 mA	-	2.2	-	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 32 V	-	-	2.8	µA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 2.37 V	-	34	-	A
I_{GSS}	gate leakage current	V_{GS} = 9 V; V_{DS} = 0 V	-	-	280	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 9.0 A	-	20.5	-	S
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 2.37 V; I_D = 6.3 A	-	72	108	mΩ
Peak device						
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 3.8 mA	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_D = 380 mA	1.5	2.0	2.5	V
V_{GSq}	gate-source quiescent voltage	V_{DS} = 28 V; I_D = 2000 mA	-	2.2	-	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 32 V	-	-	2.8	µA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 2.37 V	-	57	-	A
I_{GSS}	gate leakage current	V_{GS} = 9 V; V_{DS} = 0 V	-	-	280	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 19.0 A	-	39.0	-	S
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 2.37 V; I_D = 13.3 A	-	37	62	mΩ

Table 7. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH; f_1 = 1807.5 MHz; f_2 = 1877.5 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 800 mA (main); $V_{GS(amp)peak}$ = 1.0 V; T_{case} = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at frequencies from 1805 MHz to 1880 MHz.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$P_{L(AV)}$ = 93 W	15.0	16.0	-	dB
RL_{in}	input return loss	$P_{L(AV)}$ = 93 W	-	−19	−13	dB
η_D	drain efficiency	$P_{L(AV)}$ = 93 W	45	50	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)}$ = 93 W	-	−26	−22	dBc

Table 8. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH; f = 1807.5 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 800 mA (main); $V_{GS(amp)peak}$ = 1.0 V; T_{case} = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at a frequency of 1805 MHz.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
PAR_O	output peak-to-average ratio	$P_{L(AV)}$ = 118 W	5.8	6.3	-	dB
$P_{L(M)}$	peak output power	$P_{L(AV)}$ = 118 W	440	510	-	W

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7. Test information

7.1 Ruggedness in Doherty operation

The BLC10G18XS-550AVT is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V; f = 1807.5 MHz; P_L = 213 W (5 dB OBO); 46 % clipping.

7.2 Impedance information

Table 9. Typical impedance of main device

Measured load-pull data of main device; I_{Dq} = 1000 mA (main); V_{DS} = 28 V; pulsed CW (t_p = 100 μs; δ = 10 %).

f	Z_S [1]	Z_L [1]	P_L [2]	η_D [2]	G_p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
Maximum power load					
1805	1.4 – 4.9i	1.8 – 3.1i	269	62.8	17.6
1845	1.6 – 5.2i	1.8 – 3.1i	266	63.2	18.0
1880	2.1 – 5.6i	1.7 – 3.2i	265	60.7	18.0
Maximum drain efficiency load					
1805	1.4 – 4.9i	3.1 – 2.3i	213	69.6	19.4
1845	1.6 – 5.2i	2.8 – 2.3i	216	69.3	19.6
1880	2.1 – 5.6i	2.5 – 2.1i	211	69.2	19.7

[1] Z_S and Z_L defined in Figure 1.

[2] At 3 dB gain compression.

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Table 10. Typical impedance of peak device

Measured load-pull data of peak device; I_{Dq} = 2100 mA (peak); V_{DS} = 28 V; pulsed CW (t_p = 100 μs; δ = 10 %).

f	Z_S [1]	Z_L [1]	P_L [2]	η_D [2]	G_p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
Maximum power load					
1805	1.7 – 5.6i	1.0 – 3.3i	488	57.6	15.8
1845	2.0 – 6.0i	1.0 – 3.4i	481	56.3	16.0
1880	2.6 – 6.5i	1.1 – 3.5i	475	56.0	16.2
Maximum drain efficiency load					
1805	1.7 – 5.6i	1.7 – 2.6i	378	66.0	17.7
1845	2.0 – 6.0i	1.5 – 2.4i	343	65.4	18.2
1880	2.6 – 6.5i	1.5 – 2.5i	356	65.1	18.2

[1] Z_S and Z_L defined in Figure 1.

[2] At 3 dB gain compression.

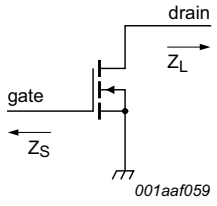


Fig 1. Definition of transistor impedance

7.3 Recommended impedances for Doherty design

Table 11. Typical impedance of main at 1 : 1 load

Measured load-pull data of main device; I_{Dq} = 1000 mA (main); V_{DS} = 28 V; pulsed CW (t_p = 100 μs; δ = 10 %).

f	Z_S [1]	Z_L [1]	$P_{L(3dB)}$ [2]	η_D [2]	G_p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1805	1.7 – j5.0	1.8 – j3.6	244	39.9	20.0
1845	2.1 – j5.3	1.7 – j3.3	247	40.5	20.4
1880	2.5 – j5.7	1.7 – j3.0	247	41.7	20.8

[1] Z_S and Z_L defined in Figure 1.

[2] At $P_{L(AV)}$ = 115 W.

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Table 12. Typical impedance of main device at 1 : 2.5 load

Measured load-pull data of main device; I_{Dq} = 1000 mA (main); V_{DS} = 28 V; pulsed CW (t_p = 100 μs; δ = 10 %).

f	Z_S [1]	Z_L [1]	$P_{L(3dB)}$ [2]	η_D [2]	G_p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1805	1.7 – j5.0	3.9 – j1.3	144	55.5	22.9
1845	2.1 – j5.3	3.8 – j1.1	134	56.5	23.5
1880	2.5 – j5.7	3.8 – j0.8	124	56.4	23.9

[1] Z_S and Z_L defined in Figure 1.

[2] At $P_{L(AV)}$ = 115 W.

Table 13. Typical impedance of peak device at 1 : 1 load

Measured load-pull data of peak device; I_{Dq} = 2100 mA (peak); V_{DS} = 28 V; pulsed CW (t_p = 100 μs; δ = 10 %).

f	Z_S [1]	Z_L [1]	$P_{L(3dB)}$ [2]	η_D [2]	G_p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1805	1.6 – j5.1	1.7 – j3.9	397	31.5	18.7
1845	2.0 – j5.5	1.6 – j3.7	416	31.2	19.0
1880	3.0 – j6.4	1.5 – j3.5	422	31.5	19.4

[1] Z_S and Z_L defined in Figure 1.

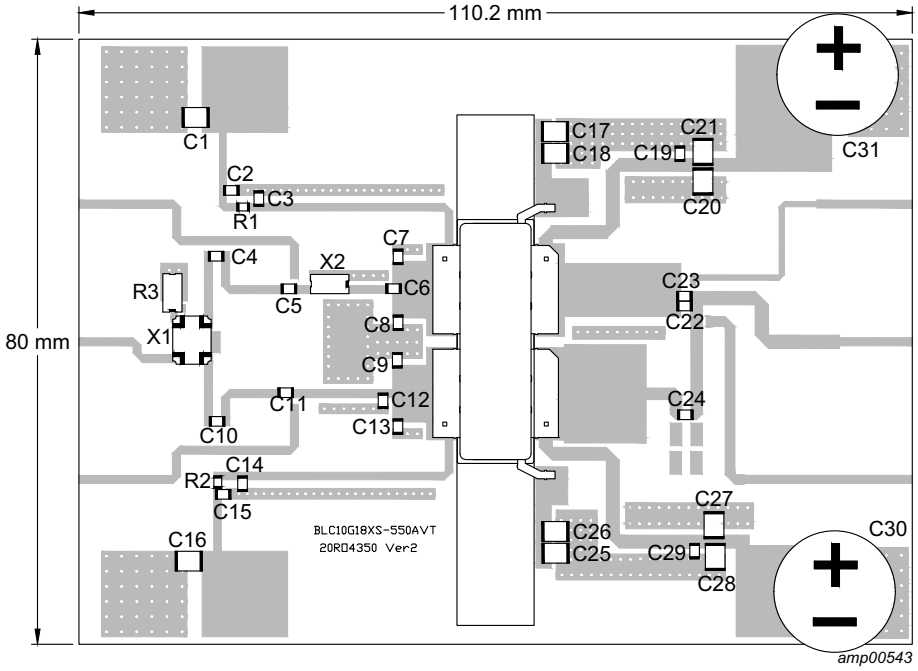
[2] At $P_{L(AV)}$ = 115 W.

Table 14. Off-state impedances of peak device

f	Z_{off}
(MHz)	(Ω)
1805	1.0 – j1.2
1845	0.7 – j0.4
1880	0.5 + j0.2

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7.4 Test circuit



Printed-Circuit Board (PCB): Rogers RO4350; thickness = 0.508 mm; thickness copper plating = 35 μm.

See Table 15 for a list of components.

Fig 2. Component layout

Table 15. List of components

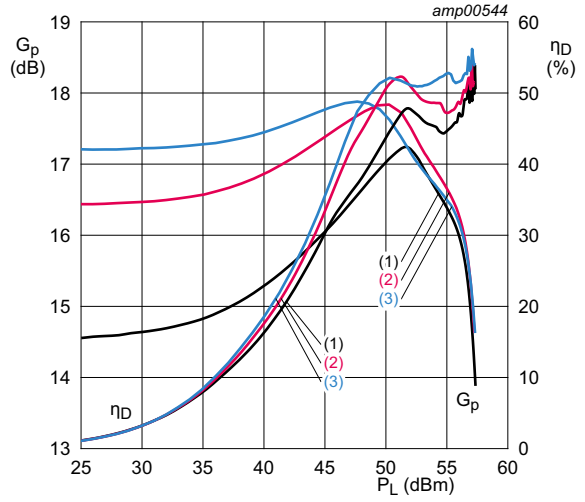
See Figure 2 for component layout.

Component	Description	Value	Remarks
C1, C16, C17, C18, C20, C21, C25, C26, C27, C28	multilayer ceramic chip capacitor	4.7 μF, 50 V	SMD 1210, Murata: GRM32ER71H475KA88L
C2, C15	multilayer ceramic chip capacitor	100 nF, 50 V	GRM21BR71H104KA01L
C3, C4, C5, C6,C10, C11, C14, C19, C24, C29	multilayer ceramic chip capacitor	10 pF	SMD 0805, ATC 600F HiQ, 250 V
C7, C9, C22, C23	multilayer ceramic chip capacitor	2.0 pF	SMD 0805, ATC 600F HiQ, 250 V
C8, C13	multilayer ceramic chip capacitor	1.8 pF	SMD 0805, ATC 600F HiQ, 250 V
C12	multilayer ceramic chip capacitor	0.5 pF	SMD 0805, ATC 600F HiQ, 250 V
C30, C31	electrolytic capacitor	470 μF, 60 V	
R1, R2	resistor	4.7 Ω, 1 %	SMD 0805
R3	resistor	50 Ω, 25 W	Anaren: C16A50Z4
X1	hybrid coupler	2 dB, 90°	Anaren Xinger III: X3C20F1-02
X2	attenuator	2 dB, 7 W	Anaren: D10AA2Z4

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7.5 Graphical data

7.5.1 Pulsed CW



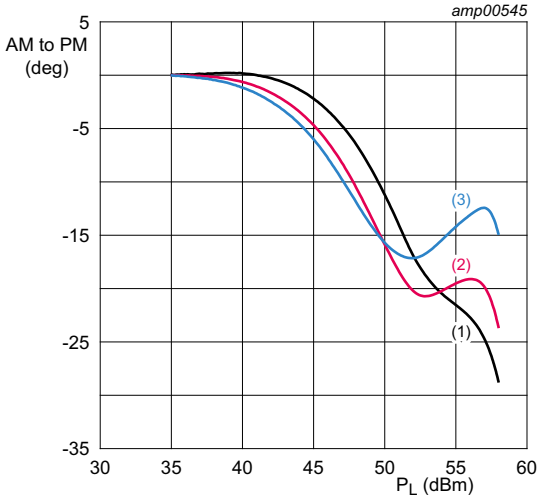
V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

(3) f = 1880 MHz

Fig 3. Power gain and drain efficiency as function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

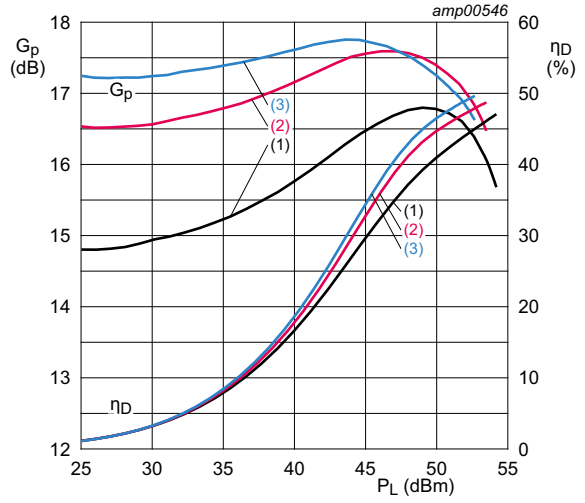
(3) f = 1880 MHz

Fig 4. Normalized AM to PM as a function of output power; typical values

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7.5.2 1-Carrier W-CDMA

Test signal: 3GPP test model 1; 1 to 64 DPCH (100 % clipping): PAR = 7.5 dB per carrier at 0.01 % probability on CCDF per carrier.



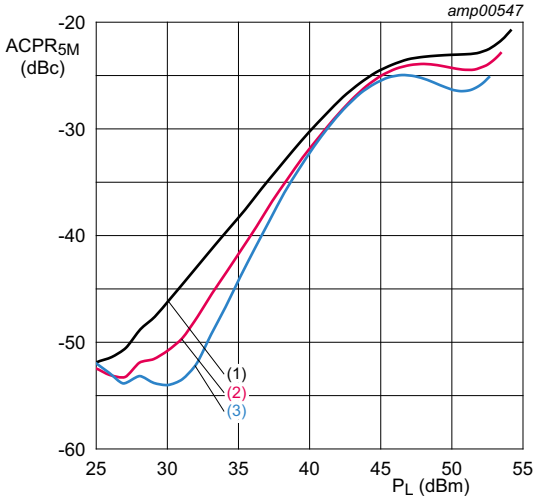
V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

(3) f = 1880 MHz

Fig 5. Power gain and drain efficiency as function of output power; typical values



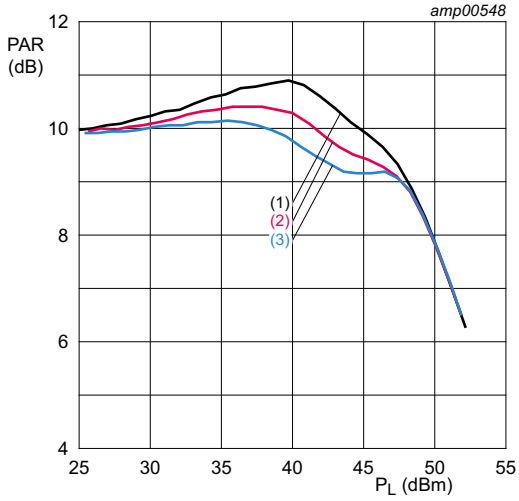
V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

(3) f = 1880 MHz

Fig 6. Adjacent channel power ratio (5 MHz) as a function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

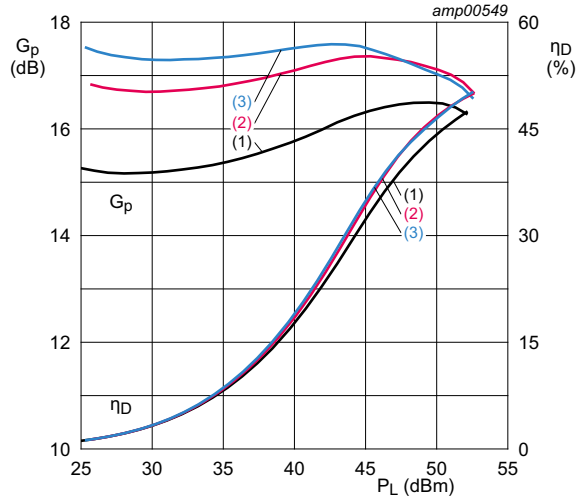
(3) f = 1880 MHz

Fig 7. Peak-to-average power ratio as a function of output power; typical values

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7.5.3 2-Carrier W-CDMA

Test signal: 3GPP test model 1; 1 to 64 DPCH (46 % clipping): PAR = 7.5 dB per carrier at 0.01 % probability on CCDF per carrier.



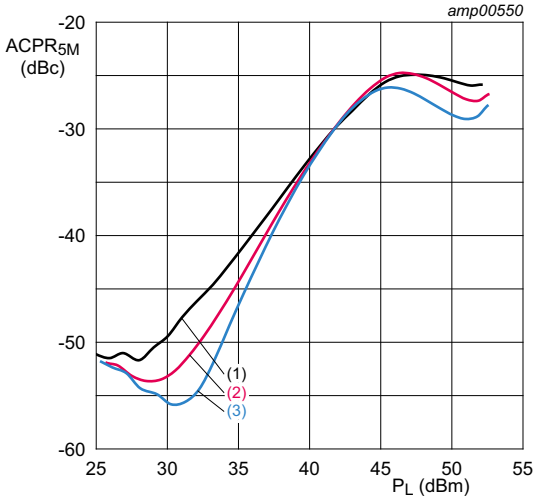
V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

(1) f = 1805 MHz

(2) f = 1842.5 MHz

(3) f = 1880 MHz

Fig 8. Power gain and drain efficiency as function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

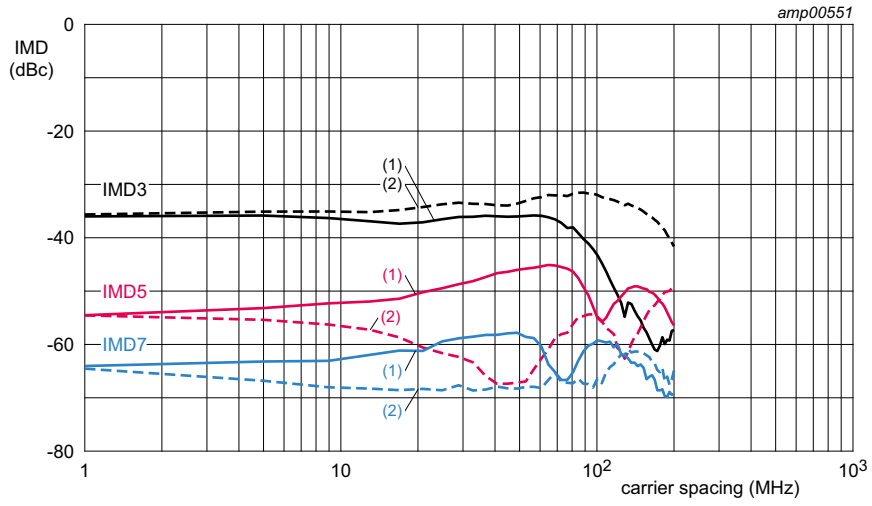
(1) f = 1805 MHz

(2) f = 1842.5 MHz

(3) f = 1880 MHz

Fig 9. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

7.5.4 2-Tone VBW



V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

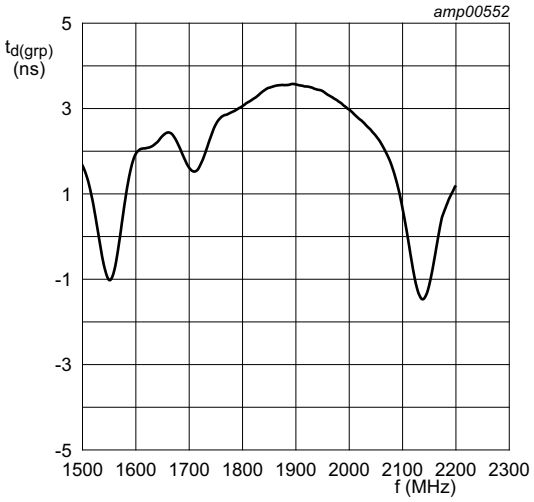
(1) IMD low

(2) IMD high

Fig 10. VBW capability

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7.5.5 Group delay



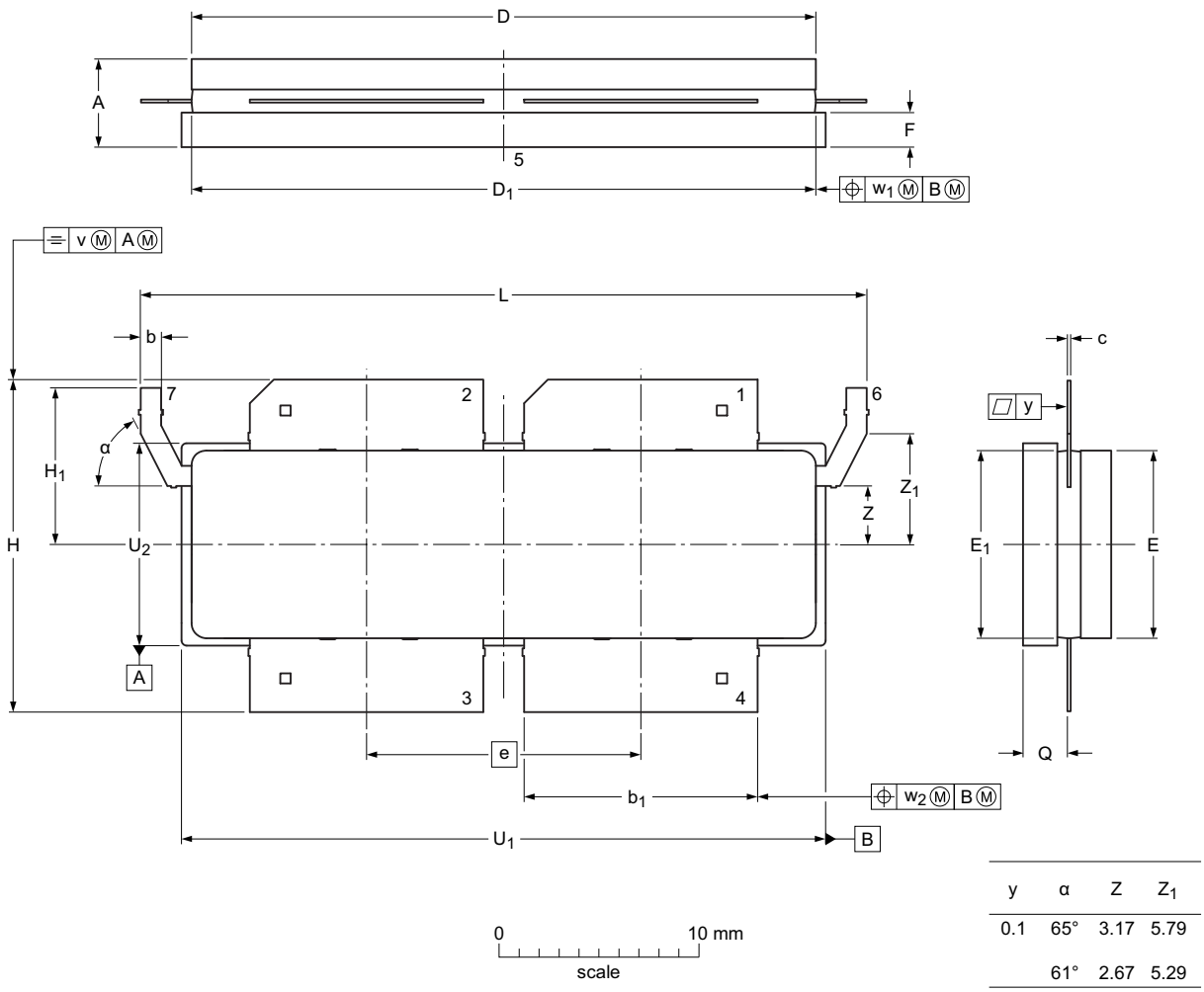
V_{DS} = 32 V; I_{Dq} = 800 mA; $V_{GS(amp)peak}$ = 1.05 V.

Fig 11. Group delay time as a function of frequency; typical values

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8. Package outline

Air cavity plastic earless flanged package; 6 leads **SOT1258-4**



y	α	Z	Z_1
0.1	65°	3.17	5.79
	61°	2.67	5.29

Dimensions

Unit		A	b	b_1	c	D	D_1	E	E_1	e	L	F	H	H_1	Q(1)	U_1	U_2	v	w_1	w_2
mm	max	4.52	1.12	11.78	0.18	31.44	31.34	9.60	9.50	13.72	36.42	1.73	16.71	8.12	2.25	32.33	10.23	0.5	0.5	0.5
	nom																			
	min	4.12	0.91	11.58	0.13	31.04	31.14	9.20	9.30		36.22	1.53	16.51	7.62	2.03	32.13	10.03			

Note
1. Dimension Q is measured 0.1 mm away from the flange.
2. Ringframe and/or ringframe glue shall not overhang at the side of the flange.

sot1258-4_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1258-4						17-08-31

Fig 12. Package outline SOT1258-4

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9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

Table 16. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C3 [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	2 [2]

[1] CDM classification C3 is granted to any part that passes after exposure to an ESD pulse of 1000 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

10. Abbreviations

Table 17. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
OBO	Output Back Off
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VBW	Video BandWidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

11. Revision history

Table 18. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLC10G18XS-550AVT v.1	20171221	Product data sheet	-	-

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14. Contents

1 Product profile 1
1.1 General description 1
1.2 Features and benefits 1
1.3 Applications 1
2 Pinning information 2
3 Ordering information 2
4 Limiting values 2
5 Thermal characteristics 2
6 Characteristics 3
7 Test information 4
7.1 Ruggedness in Doherty operation 4
7.2 Impedance information 4
7.3 Recommended impedances for Doherty design 5
7.4 Test circuit 7
7.5 Graphical data 8
7.5.1 Pulsed CW 8
7.5.2 1-Carrier W-CDMA 9
7.5.3 2-Carrier W-CDMA 10
7.5.4 2-Tone VBW 10
7.5.5 Group delay 11
8 Package outline 12
9 Handling information 13
10 Abbreviations 13
11 Revision history 13
12 Legal information 14
12.1 Data sheet status 14
12.2 Definitions 14
12.3 Disclaimers 14
12.4 Trademarks 15
13 Contact information 15
14 Contents 16

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